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## Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

### Details

Product Status	Not For New Designs
Number of LABs/CLBs	11875
Number of Logic Elements/Cells	95000
Total RAM Bits	5435392
Number of I/O	520
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m100se-7fn1152c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m100se-7fn1152c</a>

**Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection**

Device	ECP2M20	ECP2M35	ECP2M50	ECP2M70	ECP2M100
LUTs (K)	19	34	48	67	95
sysMEM Blocks (18kb)	66	114	225	246	288
Embedded Memory (Kbits)	1217	2101	4147	4534	5308
Distributed Memory (Kbits)	41	71	101	145	202
sysDSP Blocks	6	8	22	24	42
18x18 Multipliers	24	32	88	96	168
GPLL+SPLL+DLL	2+6+2	2+6+2	2+6+2	2+6+2	2+6+2
Maximum Available I/O	304	410	410	436	520
<b>Packages and SERDES / I/O Combinations</b>					
256-ball fpBGA (17 x 17 mm)	4 / 140	4 / 140			
484-ball fpBGA (23 x 23 mm)	4 / 304	4 / 303	4 / 270		
672-ball fpBGA (27 x 27 mm)		4 / 410	8 / 372		
900-ball fpBGA (31 x 31 mm)			8 / 410	16 / 416	16 / 416
1152-ball fpBGA (35 x 35 mm)				16 / 436	16 / 520

## Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

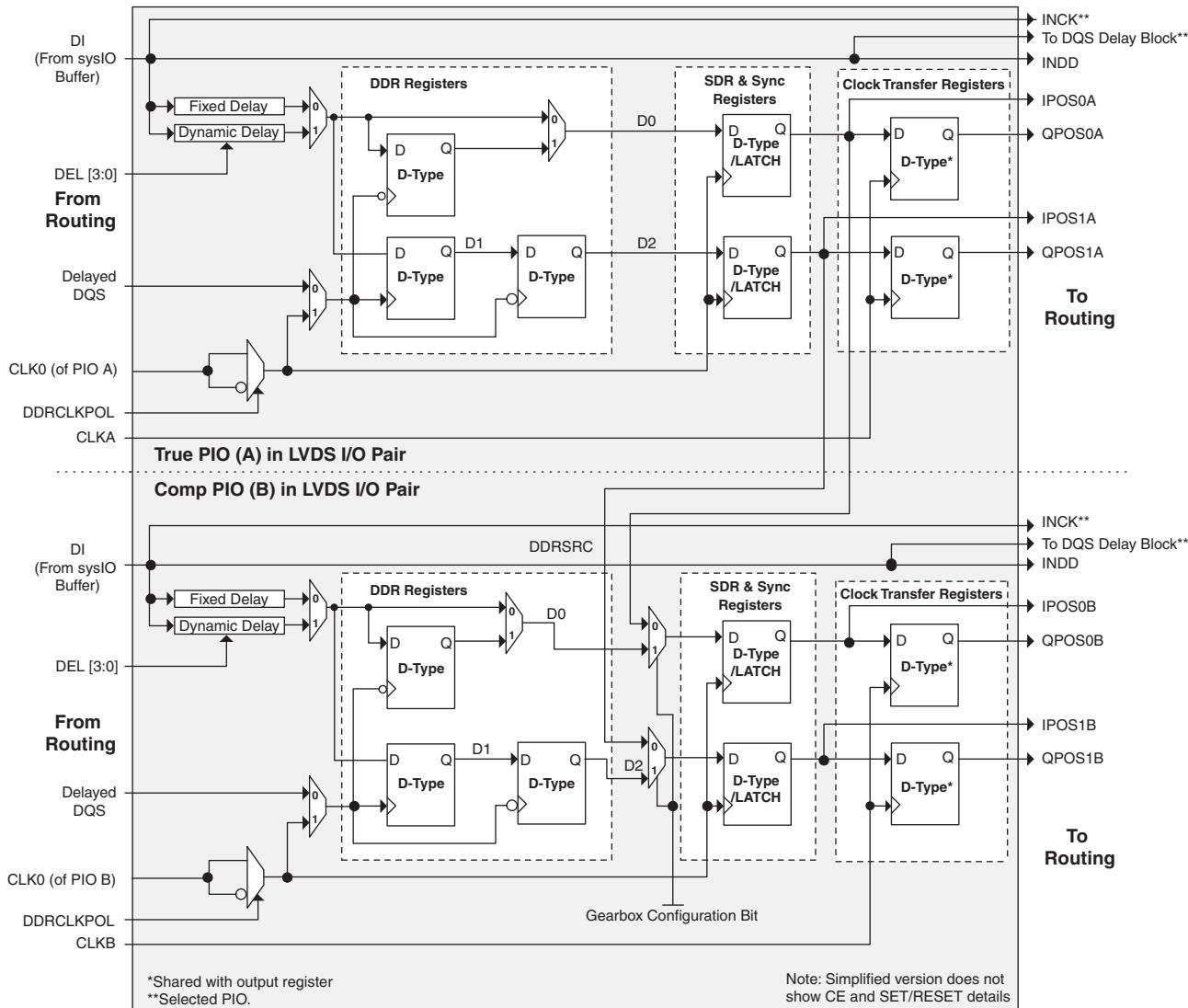
Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

By combining input blocks of the complementary PIOs and sharing some registers from output blocks, a gearbox function can be implemented, which takes a double data rate signal applied to PIOA and converts it as four data streams, IPOS0A, IPOS1A, IPOS0B and IPOS1B. Figure 2-29 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to the system clock domain. For further information about this topic, see the DDR Memory section of this data sheet.

**Figure 2-29. Input Register Block for Left, Right and Bottom Edges**



## sysI/O Differential Electrical Characteristics

### LVDS

#### Over Recommended Operating Conditions

Parameter	Description	Test Conditions	Min.	Typ.	Max.	Units
$V_{INP}$ , $V_{INM}$	Input Voltage		0	—	2.4	V
$V_{CM}$	Input Common Mode Voltage	Half the Sum of the Two Inputs	0.05	—	2.35	V
$V_{THD}$	Differential Input Threshold	Difference Between the Two Inputs	+/-100	—	—	mV
$I_{IN}$	Input Current	Power On or Power Off	—	—	+/-10	$\mu$ A
$V_{OH}$	Output High Voltage for $V_{OP}$ or $V_{OM}$	$R_T = 100$ Ohm	—	1.38	1.60	V
$V_{OL}$	Output Low Voltage for $V_{OP}$ or $V_{OM}$	$R_T = 100$ Ohm	0.9V	1.03	—	V
$V_{OD}$	Output Voltage Differential	$(V_{OP} - V_{OM})$ , $R_T = 100$ Ohm	250	350	450	mV
$\Delta V_{OD}$	Change in $V_{OD}$ Between High and Low		—	—	50	mV
$V_{OS}$	Output Voltage Offset	$(V_{OP} + V_{OM})/2$ , $R_T = 100$ Ohm	1.125	1.20	1.375	V
$\Delta V_{OS}$	Change in $V_{OS}$ Between H and L		—	—	50	mV
$I_{SA}$	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Ground	—	—	24	mA
$I_{SAB}$	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Each Other	—	—	12	mA

### Differential HSTL and SSTL

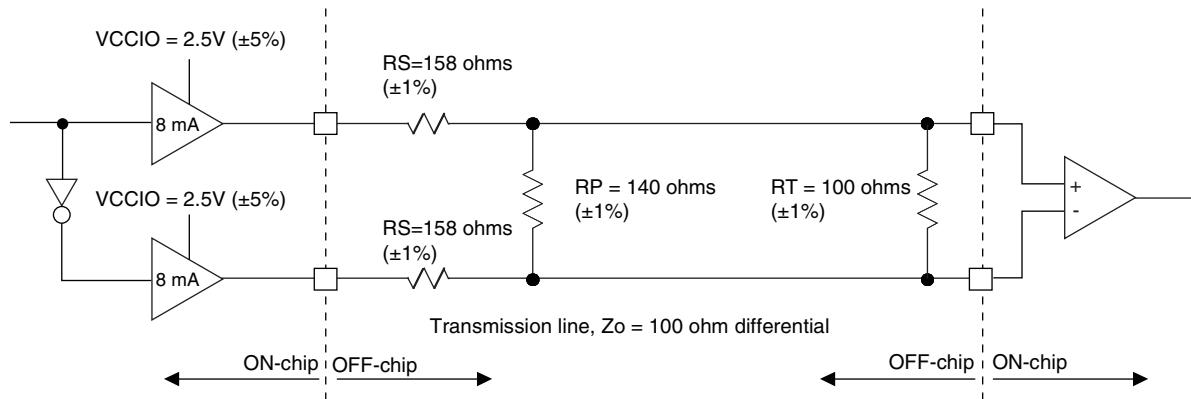
Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

## LVDS25E

The top and bottom sides of LatticeECP2/M devices support LVDS outputs via emulated complementary LVCMS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in Figure 3-1 is one possible solution for point-to-point signals.

**Figure 3-1. LVDS25E Output Termination Example**



**Table 3-2. LVDS25E DC Conditions**

Parameter	Description	Typical	Units
$V_{CCIO}$	Output Driver Supply (+/-5%)	2.50	V
$Z_{OUT}$	Driver Impedance	20	$\Omega$
$R_S$	Driver Series Resistor (+/-1%)	158	$\Omega$
$R_P$	Driver Parallel Resistor (+/-1%)	140	$\Omega$
$R_T$	Receiver Termination (+/-1%)	100	$\Omega$
$V_{OH}$	Output High Voltage	1.43	V
$V_{OL}$	Output Low Voltage	1.07	V
$V_{OD}$	Output Differential Voltage	0.35	V
$V_{CM}$	Output Common Mode Voltage	1.25	V
$Z_{BACK}$	Back Impedance	100.5	$\Omega$
$I_{DC}$	DC Output Current	6.03	mA

## LVCMS33D

All I/O banks support emulated differential I/O using the LVCMS33D I/O type. This option, along with the external resistor network, provides the system designer the flexibility to place differential outputs on an I/O bank with 3.3V VCCIO. The default drive current for LVCMS33D output is 12mA with the option to change the device strength to 4mA, 8mA, 16mA or 20mA. Follow the LVCMS33 specifications for the DC characteristics of the LVCMS33D.

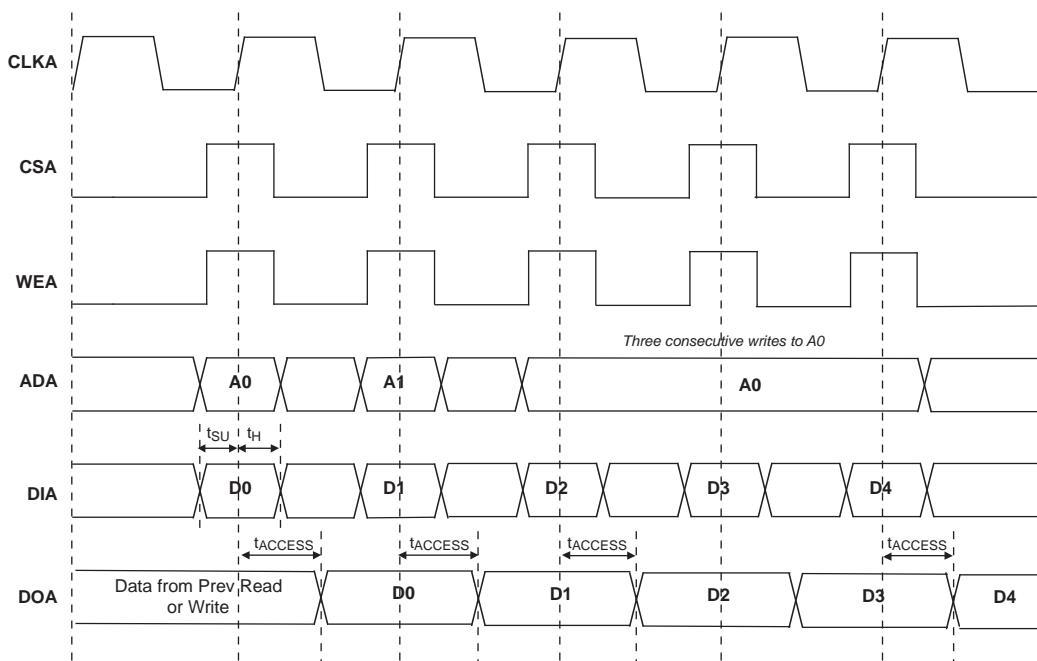
## Register-to-Register Performance (Continued)

Function	-7 Timing	Units
36x36 Multiplier (All Registers)	372	MHz
18x18 Multiplier/Accumulate (Input and Output Registers)	295	MHz
18x18 Multiplier-Add/Sub-Sum (All Registers)	420	MHz
<b>DSP IP Functions</b>		
16-Tap Fully-Parallel FIR Filter	304	MHz
1024-pt, Radix 4, Decimation in Frequency FFT	227	MHz
8x8 Matrix Multiplier	223	MHz

## Derating Timing Tables

Logic timing provided in the following sections of this data sheet and the Diamond design tool are worst case numbers in the operating range. Actual delays at nominal temperature and voltage for best case process, can be much better than the values given in the tables. The Diamond design tool can provide logic timing numbers at a particular temperature and voltage.

**Figure 3-11. Write Through (SP Read/Write on Port A, Input Registers Only)**



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

**LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100**

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Single Ended User I/O		270	372	410	416	436	416	520
Differential Pair User I/O		135	185	205	208	218	207	260
Configuration	TAP Pins	5	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7	7
Non Configuration	Muxed Pins	69	72	72	75	76	74	78
	Dedicated Pins	3	3	3	3	3	3	3
VCC		16	20	62	44	44	44	44
VCCAUX		8	26	18	16	12	16	12
VCCPLL		4	8	4	4	4	4	4
VCCIO	Bank0	4	5	6	6	7	6	7
	Bank1	3	4	6	6	7	6	7
	Bank2	4	5	9	9	9	9	9
	Bank3	4	5	9	9	9	9	9
	Bank4	4	4	6	6	7	6	7
	Bank5	4	5	6	6	7	6	7
	Bank6	4	5	9	9	9	9	9
	Bank7	4	5	9	9	9	9	9
	Bank8	2	2	2	2	2	2	2
GND, GND0 to GND7		57	80	122	122	134	122	134
NC		31	35	121	63	283	63	199
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	36/18	63/31	56/28	34/17	46/23	34/17	54/27
	Bank1	18/9	18/9	36/18	42/21	34/17	42/21	44/22
	Bank2	30/15	50/25	54/27	70/35	72/36	70/35	80/40
	Bank3	36/18	43/21	44/22	60/30	64/32	60/30	80/40
	Bank4	42/21	24/12	38/19	38/19	40/20	38/19	44/22
	Bank5	28/14	60/30	58/29	40/20	40/20	40/20	46/23
	Bank6	40/20	54/27	60/30	62/31	66/33	62/31	82/41
	Bank7	40/20	60/30	64/32	70/35	74/37	70/35	90/45
	Bank8	0/0	0/0	0/0	0/0	0/0	0/0	0/0
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0	0
	Bank2 (Right Edge)	7	12	13	17	18	17	20
	Bank3 (Right Edge)	9	11	11	15	16	15	20
	Bank4 (Bottom Edge)	0	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0	0
	Bank6 (Left Edge)	10	14	15	15	16	15	20
	Bank7 (Left Edge)	10	15	17	17	18	17	22
	Bank8 (Right Edge)	0	0	0	0	0	0	0

**LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)**

LFE2-35E/SE					LFE2-50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K8	GND	-			GND	-			
L10	GND	-			GND	-			
L11	GND	-			GND	-			
L12	GND	-			GND	-			
L13	GND	-			GND	-			
L15	GND	-			GND	-			
L8	GND	-			GND	-			
M10	GND	-			GND	-			
M11	GND	-			GND	-			
M12	GND	-			GND	-			
M13	GND	-			GND	-			
M15	GND	-			GND	-			
M8	GND	-			GND	-			
N10	GND	-			GND	-			
N11	GND	-			GND	-			
N12	GND	-			GND	-			
N13	GND	-			GND	-			
N15	GND	-			GND	-			
N8	GND	-			GND	-			
P14	GND	-			GND	-			
P20	GND	-			GND	-			
P3	GND	-			GND	-			
P9	GND	-			GND	-			
R10	GND	-			GND	-			
R11	GND	-			GND	-			
R12	GND	-			GND	-			
R13	GND	-			GND	-			
U17	GND	-			GND	-			
U6	GND	-			GND	-			
W2	GND	-			GND	-			
W21	GND	-			GND	-			
Y14	GND	-			GND	-			
Y9	GND	-			GND	-			
A1	GND	-			GND	-			
N18	VCCPLL	-			VCCPLL	-			
K6	NC	-			VCCPLL	-			
N6	VCCPLL	-			VCCPLL	-			
J16	NC	-			VCCPLL	-			

\* Supports true LVDS. Other differential signals must be emulated with external resistors.

\*\* These dedicated input pins can be used for PLLs or GDLLs within the respective quadrant.

\*\*\*Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

**LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)**

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C20	PT57B	1		C	PT66B	1			C
D20	PT57A	1		T	PT66A	1			T
A22	PT56B	1		C	PT65B	1			C
A21	PT56A	1		T	PT65A	1			T
GND	GNDIO1	-			GNDIO1	-			
E19	NC	-			NC	-			
C19	NC	-			NC	-			
VCCIO	VCCIO1	1			VCCIO1	1			
B21	NC	-			NC	-			
B20	NC	-			NC	-			
D19	NC	-			NC	-			
B19	NC	-			NC	-			
GND	GNDIO1	-			GNDIO1	-			
G17	NC	-			NC	-			
E18	NC	-			NC	-			
G19	NC	-			NC	-			
F17	NC	-			NC	-			
VCCIO	VCCIO1	1			VCCIO1	1			
A20	NC	-			NC	-			
A19	NC	-			NC	-			
E17	NC	-			NC	-			
D18	NC	-			NC	-			
B18	PT55B	1		C	PT55B	1			C
GND	GNDIO1	-			GNDIO1	-			
A18	PT55A	1		T	PT55A	1			T
E16	PT54B	1		C	PT54B	1			C
G16	PT54A	1		T	PT54A	1			T
F16	PT53B	1		C	PT53B	1			C
VCCIO	VCCIO1	1			VCCIO1	1			
H18	PT53A	1		T	PT53A	1			T
A17	PT52B	1		C	PT52B	1			C
B17	PT52A	1		T	PT52A	1			T
C18	PT51B	1		C	PT51B	1			C
B16	PT51A	1		T	PT51A	1			T
C17	PT50B	1		C	PT50B	1			C
GND	GNDIO1	-			GNDIO1	-			
D17	PT50A	1		T	PT50A	1			T
E15	PT49B	1		C	PT49B	1			C
VCCIO	VCCIO1	1			VCCIO1	1			
G15	PT49A	1		T	PT49A	1			T
A16	PT48B	1		C	PT48B	1			C
B15	PT48A	1		T	PT48A	1			T
D15	PT47B	1		C	PT47B	1			C
F15	PT47A	1		T	PT47A	1			T
A14	PT46B	1		C	PT46B	1			C
B14	PT46A	1		T	PT46A	1			T

**LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)**

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
Y21	PB82A	4	VREF2_4/BDQ78	T	PB100A	4	VREF2_4/BDQ96	T	
AB23	PB82B	4	VREF1_4/BDQ78	C	PB100B	4	VREF1_4/BDQ96	C	
GND	GNDIO4	-			GNDIO4	-			
AD24	CFG2	8			CFG2	8			
W20	CFG1	8			CFG1	8			
AC24	CFG0	8			CFG0	8			
V19	PROGRAMN	8			PROGRAMN	8			
AA22	CCLK	8			CCLK	8			
AB24	INITN	8			INITN	8			
AD25	DONE	8			DONE	8			
GND	GNDIO8	-			GNDIO8	-			
W21	PR77B	8	WRITEN	C	PR90B	8	WRITEN	C	
Y22	PR77A	8	CS1N	T	PR90A	8	CS1N	T	
AC25	PR76B	8	CSN	C	PR89B	8	CSN	C	
AB25	PR76A	8	D0/SPIFASTN	T	PR89A	8	D0/SPIFASTN	T	
VCCIO	VCCIO8	8			VCCIO8	8			
AD26	PR75B	8	D1	C	PR88B	8	D1	C	
AC26	PR75A	8	D2	T	PR88A	8	D2	T	
Y23	PR74B	8	D3	C	PR87B	8	D3	C	
GND	GNDIO8	-			GNDIO8	-			
W22	PR74A	8	D4	T	PR87A	8	D4	T	
AA25	PR73B	8	D5	C	PR86B	8	D5	C	
AB26	PR73A	8	D6	T	PR86A	8	D6	T	
W23	PR72B	8	D7/SPID0	C	PR85B	8	D7/SPID0	C	
VCCIO	VCCIO8	8			VCCIO8	8			
V22	PR72A	8	DI/CSSPI0N	T	PR85A	8	DI/CSSPI0N	T	
Y24	PR71B	8	DOUT/CS0N	C	PR84B	8	DOUT/CS0N	C	
Y25	PR71A	8	BUSY/SISPI	T	PR84A	8	BUSY/SISPI	T	
W24	PR70B	3	RDQ67	C	PR83B	3	RDQ80	C	
GND	GNDIO3	-			GNDIO3	-			
V23	PR70A	3	RDQ67	T	PR83A	3	RDQ80	T	
AA26	PR69B	3	RDQ67	C (LVDS)*	PR82B	3	RDQ80	C (LVDS)*	
Y26	PR69A	3	RDQ67	T (LVDS)*	PR82A	3	RDQ80	T (LVDS)*	
U21	PR68B	3	RDQ67	C	PR81B	3	RDQ80	C	
VCCIO	VCCIO3	3			VCCIO3	3			
U19	PR68A	3	RDQ67	T	PR81A	3	RDQ80	T	
W25	PR67B	3	RDQ67	C (LVDS)*	PR80B	3	RDQ80	C (LVDS)*	
W26	PR67A	3	RDQS67	T (LVDS)*	PR80A	3	RDQS80	T (LVDS)*	
GND	GNDIO3	-			GNDIO3	-			
V24	PR66B	3	RDQ67	C	PR79B	3	RDQ80	C	
V25	PR66A	3	RDQ67	T	PR79A	3	RDQ80	T	
V26	PR65B	3	RDQ67	C (LVDS)*	PR78B	3	RDQ80	C (LVDS)*	
U26	PR65A	3	RDQ67	T (LVDS)*	PR78A	3	RDQ80	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
U22	PR64B	3	RLM0_GPLL_C_FB_A/RDQ67	C	PR77B	3	RLM0_GPLL_C_FB_A/RDQ80	C	
U23	PR64A	3	RLM0_GPLLT_FB_A/RDQ67	T	PR77A	3	RLM0_GPLLT_FB_A/RDQ80	T	

**LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)**

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A7	PT35B	0		C	PT44B	0			C
B7	PT35A	0		T	PT44A	0			T
VCCIO	VCCIO0	0			VCCIO0	0			
F12	PT34B	0		C	PT43B	0			C
D10	PT34A	0		T	PT43A	0			T
H11	PT33B	0		C	PT42B	0			C
G11	PT33A	0		T	PT42A	0			T
GND	GNDIO0	-			GNDIO0	-			
A6	PT32B	0		C	PT41B	0			C
B6	PT32A	0		T	PT41A	0			T
D8	PT31B	0		C	PT40B	0			C
C8	PT31A	0		T	PT40A	0			T
VCCIO	VCCIO0	0			VCCIO0	0			
F11	PT30B	0		C	PT39B	0			C
E10	PT30A	0		T	PT39A	0			T
E9	PT29B	0		C	PT38B	0			C
D9	PT29A	0		T	PT38A	0			T
G10	PT28B	0		C	PT37B	0			C
GND	GNDIO0	-			GNDIO0	-			
H10	PT28A	0		T	PT37A	0			T
A5	PT27B	0		C	PT36B	0			C
B5	PT27A	0		T	PT36A	0			T
C7	PT26B	0		C	PT35B	0			C
VCCIO	VCCIO0	0			VCCIO0	0			
D7	PT26A	0		T	PT35A	0			T
E8	PT25B	0		C	PT34B	0			C
F10	PT25A	0		T	PT34A	0			T
F8	PT24B	0		C	PT33B	0			C
H9	PT24A	0		T	PT33A	0			T
C5	PT23B	0		C	PT32B	0			C
GND	GNDIO0	-			GNDIO0	-			
D5	PT23A	0		T	PT32A	0			T
B4	PT22B	0			PT31B	0			
VCCIO	VCCIO0	0			VCCIO0	0			
GND	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
GND	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
C4	PT10B	0		C	PT10B	0			C
GND	GNDIO0	-			GNDIO0	-			
C3	PT10A	0		T	PT10A	0			T
A4	PT9B	0		C	PT9B	0			C
A3	PT9A	0		T	PT9A	0			T
B3	PT8B	0		C	PT8B	0			C
VCCIO	VCCIO0	0			VCCIO0	0			
B2	PT8A	0		T	PT8A	0			T

**LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)**

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AA14	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
W17	PB65A	4	BDQ69	T	PB56A	4	BDQ60	T	
AA19	PB65B	4	BDQ69	C	PB56B	4	BDQ60	C	
AC15	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T	
Y18	PB68B	4	BDQ69	C	PB57B	4	BDQ60	C	
AB15	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T	
AC16	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C	
VCCIO	VCCIO4	4			VCCIO4	4			
AA17	PB60A	4	BDQS60****	T	PB59A	4	BDQ60	T	
AB16	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AA15	PB51A	4	BDQS51****	T	PB60A	4	BDQS60	T	
W16	PB59B	4	BDQ60	C	PB60B	4	BDQ60	C	
Y15	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AC17	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
AA18	PB61A	4	BDQ60	T	PB62A	4	BDQ60	T	
Y17	PB61B	4	BDQ60	C	PB62B	4	BDQ60	C	
-	-	-			VCCIO4	4			
GNDIO	GNDIO4	-			-	-			
W15	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T	
AB17	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
VCCIO	VCCIO4	4			VCCIO4	4			
V17	PB73A	4	BDQ69	T	PB72A	4	BDQ69	T	
AA20	PB73B	4	BDQ69	C	PB72B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AD13	VCC	-			LRC_SQ_VCCRX3	13			
AF14	PB47A	4	BDQ51	T	LRC_SQ_HDINP3	13			T
AE13	NC	-			LRC_SQ_VCCIB3	13			
AE14	PB41A	4	VREF2_4/BDQ42	T	LRC_SQ_HDINN3	13			C
AD16	VCC	-			LRC_SQ_VCCTX3	13			
AF17	PB51B	4	BDQ51	C	LRC_SQ_HDOUTP3	13			T
AF16	NC	-			LRC_SQ_VCCOB3	13			
AE17	PB50A	4	BDQ51	T	LRC_SQ_HDOUTN3	13			C
AD17	VCC	-			LRC_SQ_VCCTX2	13			
AE18	PB53B	4	BDQ51	C	LRC_SQ_HDOUTN2	13			C
AD18	NC	-			LRC_SQ_VCCOB2	13			
AF18	PB53A	4	BDQ51	T	LRC_SQ_HDOUTP2	13			T
AD14	VCC	-			LRC_SQ_VCCRX2	13			
AE15	PB48B	4	BDQ51	C	LRC_SQ_HDINN2	13			C
AD15	NC	-			LRC_SQ_VCCIB2	13			
AF15	PB47B	4	BDQ51	C	LRC_SQ_HDINP2	13			T
AD19	VCC	-			LRC_SQ_VCCP	13			
AC19	PB57B	4	BDQ60	C	LRC_SQ_REFCLKP	13			T
AB19	PB59A	4	BDQ60	T	LRC_SQ_REFCLKN	13			C
AE19	VCCAUX	-			LRC_SQ_VCCAUX33	13			

**LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)**

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
VCCIO	VCCIO3	3			VCCIO3	3			
U20	PR58A	3	RLM0_GPLLTI_IN_A**/RDQ57	T	PR63A	3	RLM0_GPLLTI_IN_A	T	
W24	PR57B	3	RLM0_GPLLC_FB_A/RDQ57	C (LVDS)*	PR62B	3	RLM0_GPLLC_FB_A	C*	
V24	PR57A	3	RLM0_GPLLTI_FB_A/RDQS57	T (LVDS)*	PR62A	3	RLM0_GPLLTI_FB_A	T*	
GNDIO	GNDIO3	-			GNDIO3	-			
U21	PR56A	3	RDQ57	T	PR60A	3		T	
W25	PR55B	3	RDQ57	C (LVDS)*	PR59B	3		C*	
W26	PR55A	3	RDQ57	T (LVDS)*	PR59A	3		T*	
VCCIO	VCCIO3	3			VCCIO3	3			
U18	PR54B	3	RDQ57	C	PR58B	3		C	
U22	PR54A	3	RDQ57	T	PR58A	3		T	
V25	PR53B	3	RDQ57	C (LVDS)*	PR57B	3		C*	
V26	PR53A	3	RDQ57	T (LVDS)*	PR57A	3		T*	
U24	PR51B	3	RDQ48	C	PR55B	3	RDQ52	C	
T24	PR51A	3	RDQ48	T	PR55A	3	RDQ52	T	
GNDIO	GNDIO3	-			GNDIO3	-			
T22	PR50B	3	RDQ48	C (LVDS)*	PR54B	3	RDQ52	C*	
T23	PR50A	3	RDQ48	T (LVDS)*	PR54A	3	RDQ52	T*	
U25	PR49B	3	RDQ48	C	PR53B	3	RDQ52	C	
U26	PR49A	3	RDQ48	T	PR53A	3	RDQ52	T	
VCCIO	VCCIO3	3			VCCIO3	3			
T19	PR48B	3	RDQ48	C (LVDS)*	PR52B	3	RDQ52	C*	
R19	PR48A	3	RDQS48	T (LVDS)*	PR52A	3	RDQS52	T*	
R21	PR47B	3	RDQ48	C	PR51B	3	RDQ52	C	
GNDIO	GNDIO3	-			GNDIO3	-			
R20	PR47A	3	RDQ48	T	PR51A	3	RDQ52	T	
T26	PR46B	3	RDQ48	C (LVDS)*	PR50B	3	RDQ52	C*	
R26	PR46A	3	RDQ48	T (LVDS)*	PR50A	3	RDQ52	T*	
P21	PR45B	3	RDQ48	C	PR49B	3	RDQ52	C	
VCCIO	VCCIO3	3			VCCIO3	3			
P19	PR45A	3	RDQ48	T	PR49A	3	RDQ52	T	
R23	PR44B	3	RDQ48	C (LVDS)*	PR48B	3	RDQ52	C*	
R24	PR44A	3	RDQ48	T (LVDS)*	PR48A	3	RDQ52	T*	
-	-	-			GNDIO3	-			
R22	PR42B	3	RLM2_SPLLC_FB_A	C	PR46B	3	RLM3_SPLLC_FB_A	C	
VCCIO	VCCIO3	3			VCCIO3	3			
N19	PR42A	3	RLM2_SPLLT_FB_A	T	PR46A	3	RLM3_SPLLT_FB_A	T	
P23	PR41B	3	RLM2_SPLLC_IN_A	C (LVDS)*	PR45B	3	RLM3_SPLLC_IN_A	C*	
P24	PR41A	3	RLM2_SPLLT_IN_A	T (LVDS)*	PR45A	3	RLM3_SPLLT_IN_A	T*	
GNDIO	GNDIO3	-			GNDIO3	-			
N21	PR40B	3		C	PR44B	3		C	
P22	PR40A	3		T	PR44A	3		T	
N20	PR39B	3		C (LVDS)*	PR43B	3		C*	
N22	PR39A	3		T (LVDS)*	PR43A	3		T*	
VCCIO	VCCIO3	3			VCCIO3	3			
P25	PR38B	3	VREF2_3	C	PR42B	3	VREF2_3	C	
P26	PR38A	3	VREF1_3	T	PR42A	3	VREF1_3	T	
M21	PR37B	3	PCLKC3_0	C (LVDS)*	PR41B	3	PCLKC3_0	C*	

**LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)**

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C15	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
B15	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
C14	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A18	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
C18	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
B18	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
C17	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
B17	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
A16	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		
A17	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
C16	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
B14	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B13	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
A14	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
C13	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		
-	-	-			GNDIO1	-		
-	-	-			VCCIO1	1		
E17	PT46B	1		C	PT55B	1		C
D17	PT46A	1		T	PT55A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
F17	PT45B	1		C	PT54B	1		C
D16	PT45A	1		T	PT54A	1		T
F19	PT44B	1		C	PT53B	1		C
F18	PT44A	1		T	PT53A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
E16	PT43B	1		C	PT52B	1		C
D15	PT43A	1		T	PT52A	1		T
G18	PT42B	1		C	PT51B	1		C
E15	PT42A	1		T	PT51A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
G17	PT41B	1		C	PT50B	1		C
E14	PT41A	1		T	PT50A	1		T
D14	PT40B	1		C	PT49B	1		C
D13	PT40A	1		T	PT49A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F15	PT39B	1	VREF2_1	C	PT48B	1	VREF2_1	C
E12	PT39A	1	VREF1_1	T	PT48A	1	VREF1_1	T
H17	PT38B	1	PCLKC1_0	C	PT47B	1	PCLKC1_0	C
E13	PT38A	1	PCLKT1_0	T	PT47A	1	PCLKT1_0	T
C12	PT37B	0	PCLKC0_0	C	PT46B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	-		
G15	PT37A	0	PCLKT0_0	T	PT46A	0	PCLKT0_0	T
C11	PT36B	0	VREF2_0	C	PT45B	0	VREF2_0	C
F14	PT36A	0	VREF1_0	T	PT45A	0	VREF1_0	T

**LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)**

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
J16	PT51B	1		C	PT60B	1			C
G15	PT51A	1		T	PT60A	1			T
GNDIO	GNDIO1	-			GNDIO1	-			
C16	PT50B	1		C	PT59B	1			C
D16	PT50A	1		T	PT59A	1			T
J15	PT49B	1		C	PT58B	1			C
H15	PT49A	1		T	PT58A	1			T
VCCIO	VCCIO1	1			VCCIO1	1			
A15	PT48B	1	VREF2_1	C	PT57B	1	VREF2_1		C
B15	PT48A	1	VREF1_1	T	PT57A	1	VREF1_1		T
F15	PT47B	1	PCLKC1_0	C	PT56B	1	PCLKC1_0		C
E16	PT47A	1	PCLKT1_0	T	PT56A	1	PCLKT1_0		T
C15	PT46B	0	PCLKC0_0	C	PT55B	0	PCLKC0_0		C
GNDIO	GNDIO0	-			GNDIO0	-			
D15	PT46A	0	PCLKT0_0	T	PT55A	0	PCLKT0_0		T
C14	PT45B	0	VREF2_0	C	PT54B	0	VREF2_0		C
E15	PT45A	0	VREF1_0	T	PT54A	0	VREF1_0		T
G14	PT44B	0		C	PT53B	0			C
VCCIO	VCCIO0	0			VCCIO0	0			
J14	PT44A	0		T	PT53A	0			T
F14	PT43B	0		C	PT52B	0			C
H14	PT43A	0		T	PT52A	0			T
A14	PT42B	0		C	PT51B	0			C
B14	PT42A	0		T	PT51A	0			T
D13	PT41B	0		C	PT50B	0			C
GNDIO	GNDIO0	-			GNDIO0	-			
F13	PT41A	0		T	PT50A	0			T
G13	PT40B	0		C	PT49B	0			C
VCCIO	VCCIO0	0			VCCIO0	0			
J11	PT40A	0		T	PT49A	0			T
D4	PT38B	0		C	PT47B	0			C
D5	PT38A	0		T	PT47A	0			T
E5	PT37B	0		C	PT46B	0			C
F6	PT37A	0		T	PT46A	0			T
GNDIO	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
F7	PT34B	0		C	PT43B	0			C
D8	PT34A	0		T	PT43A	0			T
GNDIO	GNDIO0	-			GNDIO0	-			
J13	PT32B	0		C	PT41B	0			C
G11	PT32A	0		T	PT41A	0			T
H13	PT31B	0		C	PT40B	0			C
H12	PT31A	0		T	PT40A	0			T
VCCIO	VCCIO0	0			VCCIO0	0			
E8	PT30B	0		C	PT39B	0			C
D9	PT30A	0		T	PT39A	0			T
D12	PT28B	0		C	PT37B	0			C
GNDIO	GNDIO0	-			GNDIO0	-			

**LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)**

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G7	PL8A	7	LDQ6	T (LVDS)*	NC	-			
G8	PL6A	7	LDQS6****	T (LVDS)*	NC	-			
G9	PL5A	7	LDQ6	T	NC	-			
H19	NC	-			NC	-			
H20	NC	-			NC	-			
H21	NC	-			NC	-			
H22	NC	-			NC	-			
H6	PL8B	7	LDQ6	C (LVDS)*	NC	-			
H8	PL5B	7	LDQ6	C	NC	-			
H9	PL2A	7	LDQ6	T (LVDS)*	NC	-			
J10	PL2B	7	LDQ6	C (LVDS)*	NC	-			
J20	NC	-			NC	-			
J21	NC	-			NC	-			
J9	PL4A	7	LDQ6	T (LVDS)*	NC	-			
K9	PL4B	7	LDQ6	C (LVDS)*	NC	-			
R9	NC	-			NC	-			
U22	NC	-			NC	-			
W9	NC	-			NC	-			
N13	VCCPLL	-			VCCPLL	-			
N18	VCCPLL	-			VCCPLL	-			
V13	VCCPLL	-			VCCPLL	-			
V18	VCCPLL	-			VCCPLL	-			

\* Supports true LVDS. Other differential signals must be emulated with external resistors.

\*\* These dedicated input pins can be used for GPLLS or GDLLs within the respective quadrant.

\*\*\* These sysCONFIG pins are dedicated I/O pins for configuration. The outputs are actively driven during normal device operation.

\*\*\*\*Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

**LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)**

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U7	PL60A	6	VREF2_6/LDQ63	T
T8	PL60B	6	VREF1_6/LDQ63	C
R3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
R2	PL61B	6	LDQ63	C (LVDS)*
R1	PL62A	6	LDQ63	T
T1	PL62B	6	LDQ63	C
GNDIO	GNDIO6	-		
VCCIO	VCCIO6	6		
T3	PL65A	6	LLM4_SPLLTT_IN_A/LDQ63	T (LVDS)*
T2	PL65B	6	LLM4_SPLLC_IN_A/LDQ63	C (LVDS)*
U9	PL66A	6	LLM4_SPLLTT_FB_A/LDQ63	T
U8	PL66B	6	LLM4_SPLLC_FB_A/LDQ63	C
GNDIO	GNDIO6	-		
U5	PL68A	6	LDQ72	T (LVDS)*
U4	PL68B	6	LDQ72	C (LVDS)*
V9	PL69A	6	LDQ72	T
V7	PL69B	6	LDQ72	C
VCCIO	VCCIO6	6		
U3	PL70A	6	LDQ72	T (LVDS)*
U2	PL70B	6	LDQ72	C (LVDS)*
V8	PL71A	6	LDQ72	T
U6	PL71B	6	LDQ72	C
GNDIO	GNDIO6	-		
U1	PL72A	6	LDQS72	T (LVDS)*
V2	PL72B	6	LDQ72	C (LVDS)*
V5	PL73A	6	LDQ72	T
VCCIO	VCCIO6	6		
V6	PL73B	6	LDQ72	C
V1	PL74A	6	LDQ72	T (LVDS)*
W1	PL74B	6	LDQ72	C (LVDS)*
W5	PL75A	6	LDQ72	T
GNDIO	GNDIO6	-		
W6	PL75B	6	LDQ72	C
W3	PL77A	6	LDQ81	T (LVDS)*
W4	PL77B	6	LDQ81	C (LVDS)*
W2	PL78A	6	LDQ81	T
Y4	PL78B	6	LDQ81	C
Y1	PL79A	6	LDQ81	T (LVDS)*
VCCIO	VCCIO6	6		
Y2	PL79B	6	LDQ81	C (LVDS)*
Y5	PL80A	6	LDQ81	T
Y6	PL80B	6	LDQ81	C

**LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)**

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AN29	LRC_SQ_VCCRX2	13			LRC_SQ_VCCRX2	13		
AM28	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13		C
AL27	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13		
AM29	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13		T
AL29	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13		
AL30	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13		T
AK30	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13		C
AK29	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13		
AM30	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13		T
AL31	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13		
AM31	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13		C
AN30	LRC_SQ_VCCRX1	13			LRC_SQ_VCCRX1	13		
AP30	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13		T
AL32	LRC_SQ_VCCOB1	13			LRC_SQ_VCCOB1	13		
AP31	LRC_SQ_HDOUTN1	13		C	LRC_SQ_HDOUTN1	13		C
AN31	LRC_SQ_VCCTX1	13			LRC_SQ_VCCTX1	13		
AP32	LRC_SQ_HDOUTN0	13		C	LRC_SQ_HDOUTN0	13		C
AM34	LRC_SQ_VCCOB0	13			LRC_SQ_VCCOB0	13		
AP33	LRC_SQ_HDOUTP0	13		T	LRC_SQ_HDOUTP0	13		T
AN32	LRC_SQ_VCCTX0	13			LRC_SQ_VCCTX0	13		
AM32	LRC_SQ_HDINN0	13		C	LRC_SQ_HDINN0	13		C
AN34	LRC_SQ_VCCIB0	13			LRC_SQ_VCCIB0	13		
AM33	LRC_SQ_HDINP0	13		T	LRC_SQ_HDINP0	13		T
AN33	LRC_SQ_VCCRX0	13			LRC_SQ_VCCRX0	13		
AH28	CFG2	8			CFG2	8		
AD24	CFG1	8			CFG1	8		
AJ29	CFG0	8			CFG0	8		
AF25	PROGRAMN	8			PROGRAMM	8		
AJ28	CCLK	8			CCLK	8		
AE25	INITN	8			INITN	8		
AK31	DONE	8			DONE	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AE24	WRITEN***	8			WRITEN***	8		
AJ30	CS1N***	8			CS1N***	8		
AD25	CSN***	8			CSN***	8		
AG29	D0/SPIFASTN***	8			D0/SPIFASTN***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AG28	D1***	8			D1***	8		
AG30	D2***	8			D2***	8		
AH29	D3***	8			D3***	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AF26	D4***	8			D4***	8		
AH30	D5***	8			D5***	8		
AE26	D6***	8			D6***	8		
AJ31	D7/SPID0***	8			D7/SPID0***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AG27	DI/CSSPI0N***	8			DI/CSSPI0N***	8		
AK32	DOUT/CS0N/ CSSPI1N***	8			DOUT/CS0N/ CSSPI1N***	8		
AK33	BUSY/SISPI***	8			BUSY/SISPI***	8		

**LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)**

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K11	NC	-			NC	-		
K12	NC	-			NC	-		
K13	NC	-			NC	-		
K23	NC	-			NC	-		
K24	NC	-			NC	-		
K25	NC	-			NC	-		
K26	NC	-			NC	-		
L11	NC	-			NC	-		
L12	NC	-			NC	-		
L13	NC	-			NC	-		
L14	NC	-			NC	-		
L21	NC	-			NC	-		
L22	NC	-			NC	-		
L23	NC	-			NC	-		
L24	NC	-			NC	-		
L25	NC	-			NC	-		
L26	NC	-			NC	-		
M11	NC	-			NC	-		
M24	NC	-			NC	-		
M25	NC	-			NC	-		
M6	NC	-			NC	-		
M8	NC	-			NC	-		
N10	NC	-			NC	-		
N11	NC	-			NC	-		
P10	NC	-			NC	-		
P25	NC	-			NC	-		
P26	NC	-			NC	-		
R9	NC	-			NC	-		
T11	NC	-			NC	-		
U11	NC	-			NC	-		
W11	NC	-			NC	-		
Y10	NC	-			NC	-		
Y11	NC	-			NC	-		
R15	VCCPLL	-			VCCPLL	-		
R20	VCCPLL	-			VCCPLL	-		
Y15	VCCPLL	-			VCCPLL	-		
Y20	VCCPLL	-			VCCPLL	-		

\* Supports true LVDS. Other differential signals must be emulated with external resistors.

\*\* These dedicated input pins can be used for GPLLS or GDLLs within the respective quadrant.

\*\*\* For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70, and ECP2M100).

\*\*\*\*Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.



**Ordering Information**  
**LatticeECP2/M Family Data Sheet**

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70SE-5F1152C	436	1.2V	-5	fpBGA	1152	Com	70
LFE2M70SE-6F1152C	436	1.2V	-6	fpBGA	1152	Com	70
LFE2M70SE-7F1152C	436	1.2V	-7	fpBGA	1152	Com	70
LFE2M70SE-5F900C	416	1.2V	-5	fpBGA	900	Com	70
LFE2M70SE-6F900C	416	1.2V	-6	fpBGA	900	Com	70
LFE2M70SE-7F900C	416	1.2V	-7	fpBGA	900	Com	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5F1152C	520	1.2V	-5	fpBGA	1152	Com	100
LFE2M100SE-6F1152C	520	1.2V	-6	fpBGA	1152	Com	100
LFE2M100SE-7F1152C	520	1.2V	-7	fpBGA	1152	Com	100
LFE2M100SE-5F900C	416	1.2V	-5	fpBGA	900	Com	100
LFE2M100SE-6F900C	416	1.2V	-6	fpBGA	900	Com	100
LFE2M100SE-7F900C	416	1.2V	-7	fpBGA	900	Com	100